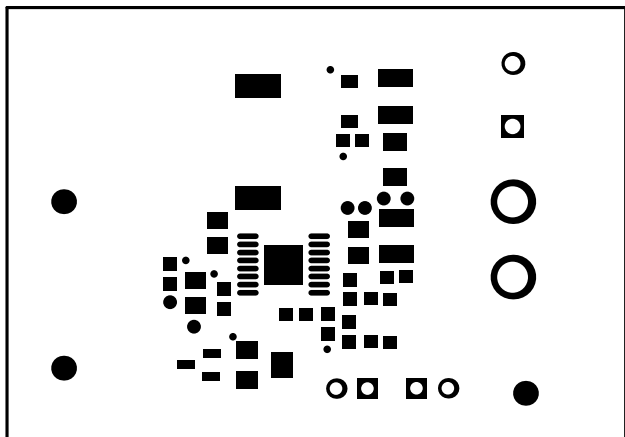


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 1/25/2015	12:36:57 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: PMP10596

REV: B

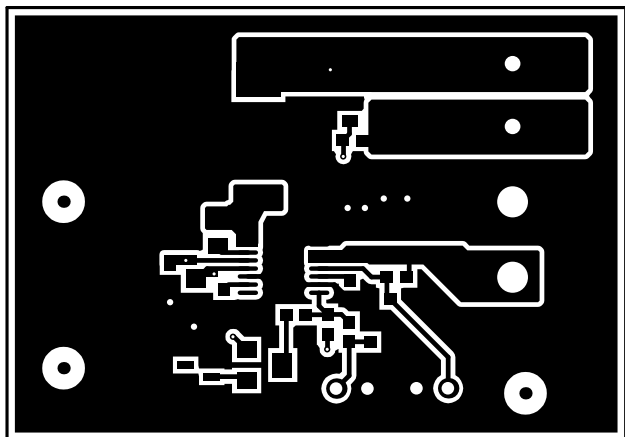
SUN REV: Not In VersionControl

LAYER NAME = Top Solder

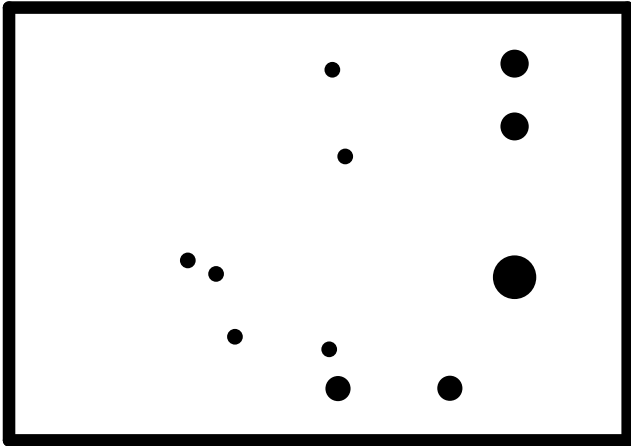
PLOT NAME = Top Solder Mask

GENERATED : 1/25/2015 12:36:58 AM

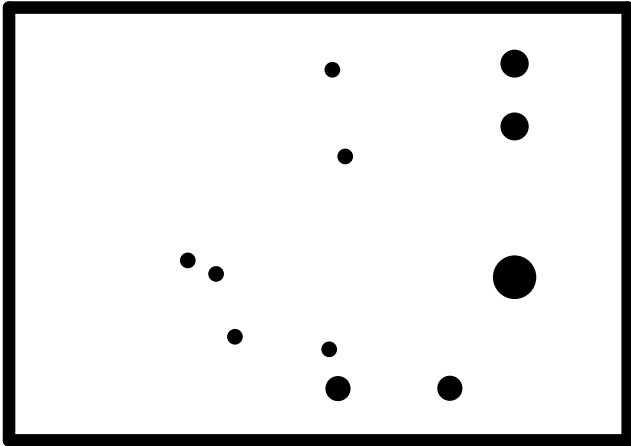
TEXAS INSTRUMENTS



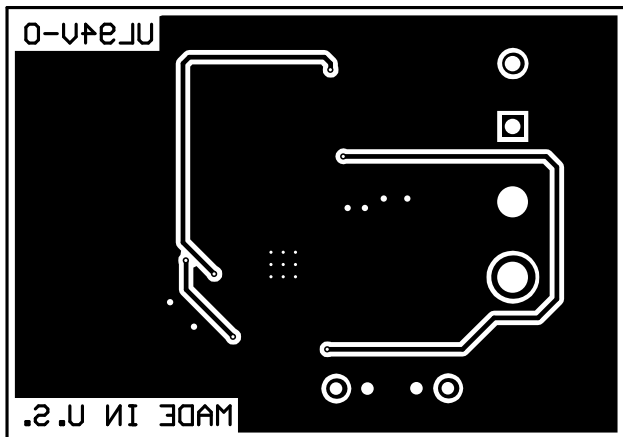
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 1/25/2015 12:36:59 AM	TEXAS INSTRUMENTS	



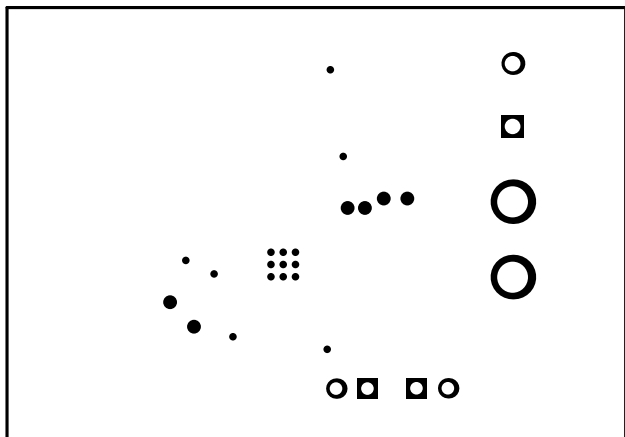
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer1	GENERATED : 1/25/2015 12:36:59 AM	TEXAS INSTRUMENTS	



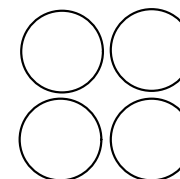
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer2	GENERATED : 1/25/2015 12:37:00 AM	TEXAS INSTRUMENTS	



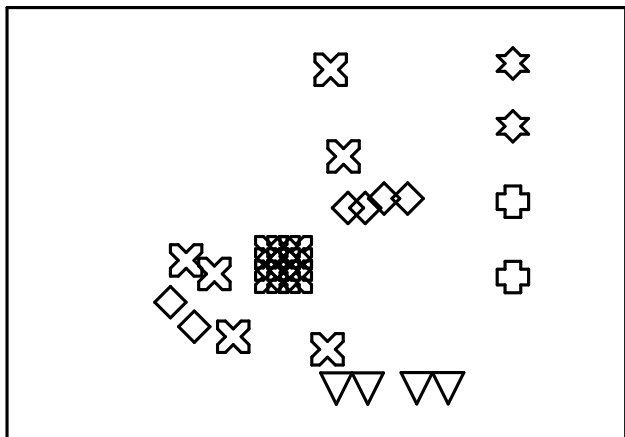
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 1/25/2015 12:37:01 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 1/25/2015 12:37:01 AM	TEXAS INSTRUMENTS	

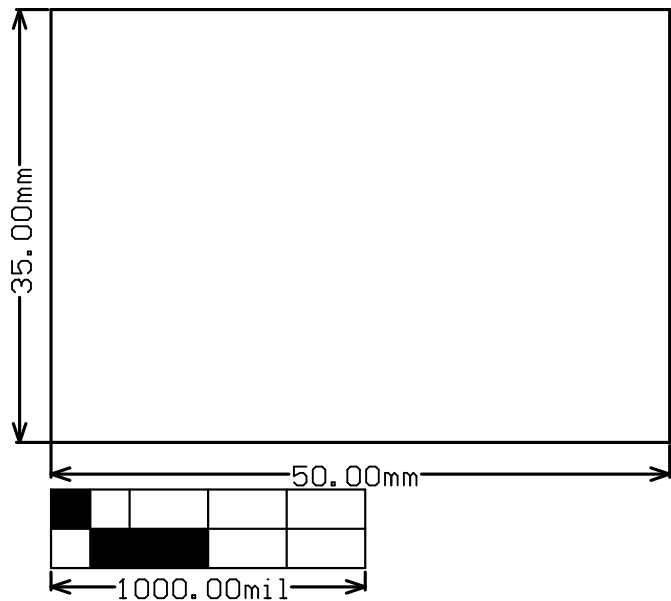


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 1/25/2015 12:37:02 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊗	15	10.00mil (0.254mm)	PTH	Round
◇	6	20.00mil (0.508mm)	PTH	Round
▽	4	40.00mil (1.016mm)	PTH	Round
☆	2	49.21mil (1.250mm)	PTH	Round
⊕	2	98.43mil (2.500mm)	PTH	Round
	29 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 1/25/2015	12:37:03 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP10596	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Mechanical 2			
PLOT NAME = Board Dimensions	GENERATED : 1/25/2015 12:37:04 AM	TEXAS INSTRUMENTS	

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